

VC3SMP85

Zigbee module

Instruction Manual



To prevent damage to the module, be sure to observe the following precautions :

- Supply voltage not more than 3.6V
- Do not modify the module
- Do not wet the module or use the module when your hands are wet
- Do not use the module for applications other than communications
- Do not force the knock on the module
- Welding process ,to prevent electrostatic damage to the module
- While using the module, don't do anything which may cause bodily harm or physical damage

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

The device has been evaluated to meet general RF exposure requirement.

To maintain compliance with FCC's RF exposure guidelines, this equipment should be installed and operated with a minimum distance of 20cm between the radiator and your body.

The host label must show “contains FCC ID: 2AINXVC3SMP85”

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1 Description

VC3SMP85 have very low power consumption (sleep current $1.8\mu\text{A}$), High Performance ZigBee solution. It uses industry-leading ZigBee Pro Stack—EmberZNet, provides stable and reliable ZigBee network. VC3SMP85 module integrated ARM®Cortex-M3 32-bit microprocessor, have extensive memory resources and I / O interfaces, Customers can quickly achieve simple or complex product development.



Figure 1.1.VC3SMP85 Module

2 Features

- 32-bit ARM® Cortex-M3 processor
- Operation at: 6, 12 or 24MHz
- +20dB normal mode output power
- 512KB flash, 64KB RAM Memory
- Low deep sleep current, with retained RAM and GPIO: $1.8\mu\text{A}$. Sleep modes selectable
- Single voltage operation: 2.1-3.6V with internal 1.8 and 1.25V regulators
- Optional OTA firmware upgrade mode
- AES-128 encryption accelerator
- Flexible ADC, UART/SPI/TWI serial communications
- Temperature range: -40 to $+85^{\circ}\text{C}$
- Normal mode link budget up to 116dB; configurable up to 120dB

3 Electrical Specifications

Table 3.1. Absolute Maximum Ratings

Parameter	Min	Max	Unit
Regulator input voltage (VDD)	-0.3	+3.6	V
Voltage on any GPIO	-0.3	VDD+0.3	V
Analog, Memory and Core volt-	-0.3	+2.0	V

age			
RF Input Power	—	+5	dBm
Storage temperature	-40	+125	°C

Table 3.2.Operating Conditions

Parameter	Min	Typ	Max	Unit
Supply voltage (VDD)	2.1	3.3	+3.6	V
Operating temperature range	-40	25	+85	°C

Table 3.3.RF Parameter

Parameter	Min	Typ	Max	Unit
Frequency range	2405	—	2480	MHz
Sensitivity(1%PER ,Boost Mode)	-102	—	-94	dBm
TX Power	—	+20	+21	dBm
Frequency tolerance (@25°C)	-96.2	—	+96.2	kHz

Note : In the open distance test,the transmission distance up to 0.497 mile

Table 3.4.Other Parameter

Parameter	Min	Typ	Min	Unit
Total TX current(+20dBm , Boost Mode)	—	157.5	—	mA
Total RX current (Boost Mode)	—	37.5	—	mA
Sleep Current	—	1.6	—	μA

4 Functional Block Diagram

VC3SMP85 with high performance ZigBee SoC and PA

Figure4.1 shows functional block diagram of the VC3SMP85 Module

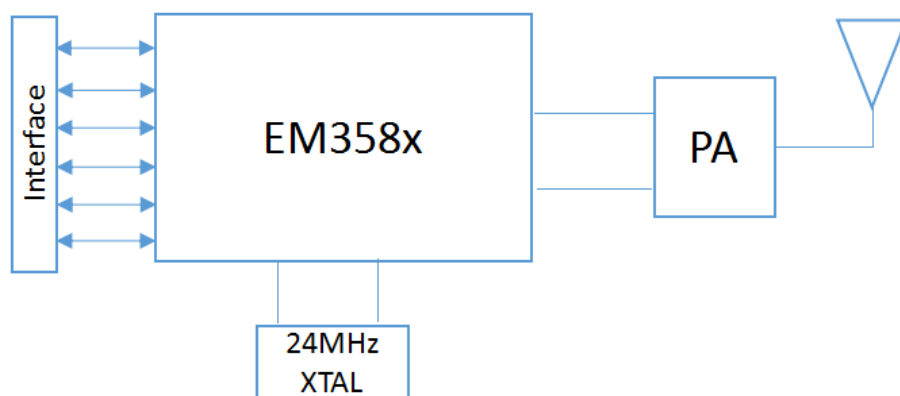


Figure 4.1.VC3SMP85 Module functional block diagram

4.1 SoC

VC3SMP85 uses Ember's EM3585 chip. The chip integrates RF RF and baseband, The MAC hardware, Hardware capture module, ARM® Cortex™-M3 microprocessor, Large capacity Flash and RAM. Therefore, the chip provides users with a low-cost, high-performance ZigBee solutions.

4.2 RF_PA

VC3SMP85 have a fully integrated, PA chips. The PA, LNA, Transmit and Receive switching circuitry, the associated matching network, and the harmonic filter all in a CMOS single-chip device. The chip can not only increase the transmission power amplified output signal can also amplify the input signal reception performance enhancement. Not only meet the IEEE802.15.4 / ZigBee all RF functional requirements, but also has a lower cost, is a cost-effective solution for Zigbee RF.

PA chips require proper use. The PC5, PC6 should be set ALT_OUT(PUSH/PULL), Through these two pins to control PA chips, transmit and receive switching channels. In order to improve RF performance, software should set the EMBER_TX_POWER_MODE_BOOST by emberSetTxPowerMode() (EmberZNet API) ,using TX Power Model. In order to avoid damage to the PA chip, during use input power must less than or equal 0dBm.

Note : When generating code using Ember Desktop, EMBER_AF_TX_POWER_MODE of the macro definition is used to set this parameter. In Desktop configuration options, as follows :

The screenshot shows the Ember Desktop configuration window with several tabs at the top: General, ZCL global, ZCL clusters, Znet stack, RF4CE stack, Printing and CLI, and HAL. The 'Znet stack' tab is selected, and the 'ZigBee PRO network configuration' section is expanded. Below this, there is a table with three columns: Name, ZigBee Device Type, and Security Type. The first row is 'Primary (default)', 'Router', and 'Home Automation Security'. Below the table, the 'Radio configuration' section is expanded, showing 'Power mode' with 'Use API' selected, and 'Enable boost power mode' checked.

Name	ZigBee Device Type	Security Type
Primary (default)	Router	Home Automation Security

▼ Radio configuration

Power mode: ☐ Use token ☒ Use API ☒ Enable boost power mode ☐ Enable the alternate transmitter output

Figure 4.2. VC3SMP85 TX Power Mode Configuration Options

4.3 Antenna

VC3SMP85 default connection board PCB antenna.

5 Pin Description

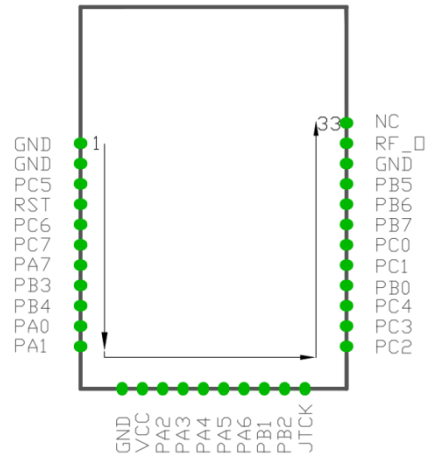


Figure 5.1.VC3SMP85 pin descriptions

Table 5.1.pin descriptions

Pin#	Signal	Direction	Description
1、2、12、31、33	GND	—	—
3	PC5	I/O	GPIO
	TX_ACTIVE	O	Output high level in TX mode
4	RESET	I	Low voltage reset
5	PC6	I/O	GPIO
	nTX_ACTIVE	O	Output low level in TX mode
6	PC7	I/O	GPIO
7	PA7	I/O	GPIO
8	PB3	I/O	GPIO
	SC1nCTS	I	CTS of UART
	SC1SCLK	I/O	Clock line of SPI
	TIM2C3	I/O	Timer 2 channel 3 input/output
9	PB4	I/O	GPIO
	TIM2C4	I/O	Timer 2channel 4 input/output
	SC1nRTS	O	RTS of UART
	SC1nSSEL	I	SPI Slave Select
10	PA0	I/O	GPIO
	TIM2C1	I/O	Timer2 channel 1 input/output
	SC2MOSI	I/O	SPI host output、slave input
11	PA1	I/O	GPIO
	TIM2C3	I/O	Timer 2 cahnnne 3 input/output

	SC2MISO	I/O	SPI host input、 slave output
13	VDD	——	Power supply (2.1——3.6V)
14	PA2	I/O	GPIO
	TIM2C4	I/O	Timer 2 channel 4 input/output
	SC2SCLK	I/O	Clock line of SPI
	SC2SCL	I/O	Clock line of cerial controller
15	PA3	I/O	GPIO
	SC2SSEL	I	SPI Slave Select
	TIM2C2	I/O	Timer2 channel 2 input/output
16	PA4	I/O	GPIO
	ADC4	Analog input	Analog input channel 4
17	PA5	I/O	GPIO
	ADC5	Analog input	Analog input channel 5
	nBootMode	I	When the chip enable, start Bootloade control pin
18	PA6	I/O	GPIO
	TIM1C3	I/O	Timer 1 channel 3 input/output
19	PB1	I/O	GPIO
	SC1MISO	O	SPI slave output
	SC1MOSI	O	SPI host output
	SC1SDA	I/O	Date cable of serial communications
	SC1TXD	O	TX interface of UART
	TIM2C1	I/O	Timer2 channel 1 input/output
20	PB2	I/O	GPIO
	SC1MISO	I	SPI host input
	SC1MOSI	I	SPI slave input
	SC1SCL	I/O	Clock line of serial communications
	SC1RXD	I	Rx interface of UART
	TIM2C2	I/O	Timer2 channel 2 input/output
21	SWCLK	I/O	Clock line of SWD interface
	JTCK	I	Clock line of JTAG interface
22	PC2	I/O	GPIO
23	PC3	I/O	GPIO
24	PC4	I/O	GPIO
	SWDIO	I/O	Date cable of SWD interface
25	PB0	I/O	GPIO
	IRQA	I	External interrupt sources A
	VREF	I/O	Input/output of ADC reference level
	TIM1CLK	I	External clock input of Timer 1
26	PC1	I/O	GPIO
	ADC3	I	Analog input channel 3
27	PC0	I/O	GPIO
28	PB7	I/O	GPIO

